



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of Rej S. Sandhu et al.

Title: METHOD FOR FORMING A METALLIZATION LAYER

Docket No.: 303.085US7

Serial No.: 10/820,291

Filed: April 8, 2004

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Examiner: Dung Le

Group Art Unit: 2818

Customer No.: 21186

Confirmation No.: 8616

Commissioner for Patents

Notice of Allowance Date:

Attn: MAIL STOP ISSUE FEE

January 25, 2007

P.O. Box 1450

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